







(0.635 mm) .025"

QMS-RA SERIES

RIGHT-ANGLE GROUND PLANE HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS-RA

Insulator Material:

Liquid Crystal Polymer Terminal & Ground Plane Material:

Phosphor Bronze

Plating: Au over 50 μ" (1.27 μm) Ni (Tin on Ground Plane Tail) Voltage Rating: 300 VAC

Operating Temp: -55 °C to +125 °C RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (026-052) (0.15 mm) .006" max (078)*

(.004" stencil solution may be available: contact IPG@samtec.com)

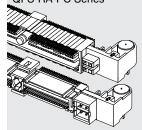
RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

Combination Signal/Power See QMS-RA-PC Series or QFS-RA-PC Series



Some lengths, styles and options are non-standard, non-returnable.

Board Mates:



- Increased insertion depth
- · Integral guide post
- PCB mounting pins

HIGH-SPEED CHANNEL PERFORMANCE

QMS-RA/QFS-RA

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

026, -052, -078

(52 total pins per bank = -D)

-016, -032, -048 (16 pairs per bank = -D-DP)

Integral metal plane for power or ground Metal guide post

PINS PER ROW PLATING QMS NO. OF PAIRS

OPTION

·SL = 10 µ" (0.25 µm) **Gold on Signal Pins** and Ground Plane, Matte Tin on tails

-D = Single-Ended -D-DP = Differential Pair

option

-MG = Metal Guide Post

MG

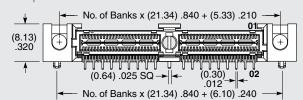
Polyimide film Pick & Place Pad

OTHER

OPTION

-TR = Tape & Reel (-016, -026, -032 & -052 positions only)

No. of Banks x (21.34) .840 + (12.45) .490 (11.87).467 (5.72)



ALSO AVAILABLE (MOQ Required)

- · Other platings
- · Plastic Guide Post option
- -02 lead style for (2.36 mm) .093" thick board
- 64 (-DP) and 104 positions per row Contact Samtec.

